

N-Channel 200-V (D-S) 175 °C MOSFET

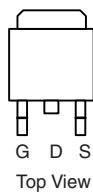
PRODUCT SUMMARY			
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ)
200	0.059 at $V_{GS} = 15$ V	33	53
	0.060 at $V_{GS} = 10$ V	33	

FEATURES

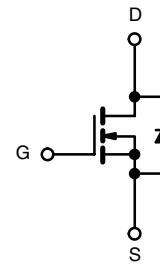
- TrenchFET® Power MOSFETs
- 150 °C Junction Temperature
- 100 % UIS and R_g Tested



TO-263



Top View



N-Channel MOSFET

Ordering Information: SUM33N20-60P-E3 (Lead (Pb)-free)

APPLICATIONS

- Power Supply
- Lighting
- Industrial

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 25	
Continuous Drain Current ($T_J = 175$ °C)	I_D	33	A
		20.8	
Pulsed Drain Current	I_{DM}	80	
Single Pulse Avalanche Current	I_{AS}	20	mJ
Single Pulse Avalanche Energy ^a	E_{AS}	20	
Maximum Power Dissipation ^a	P_D	156 ^b	W
		3.12	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R_{thJA}	40	°C/W
Junction-to-Case (Drain)	R_{thJC}	0.8	

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

SUM33N20-60P

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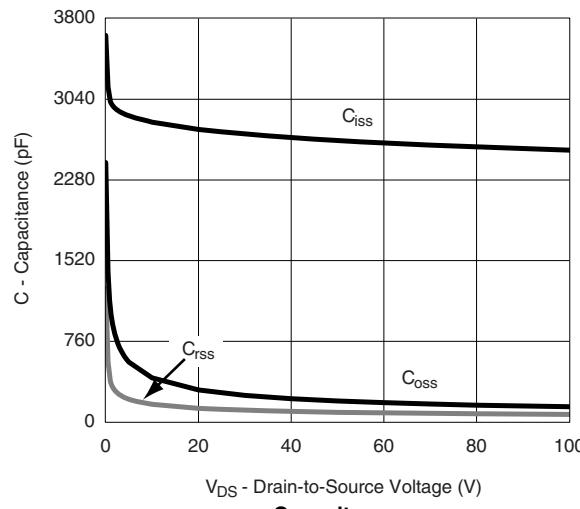
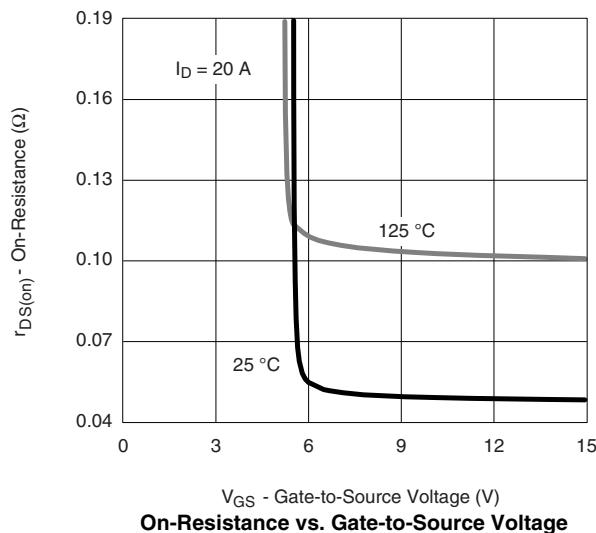
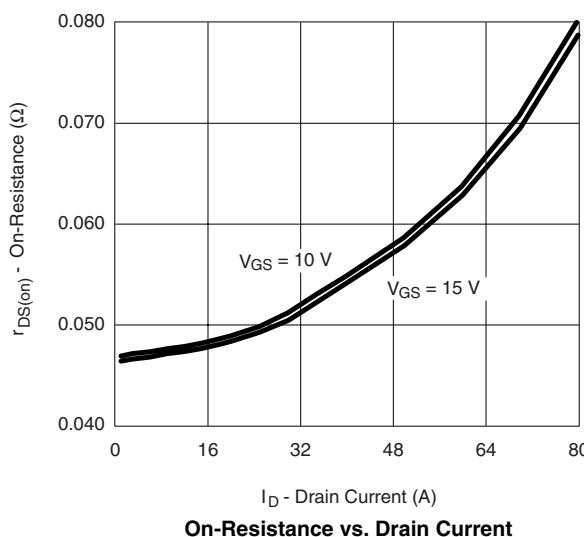
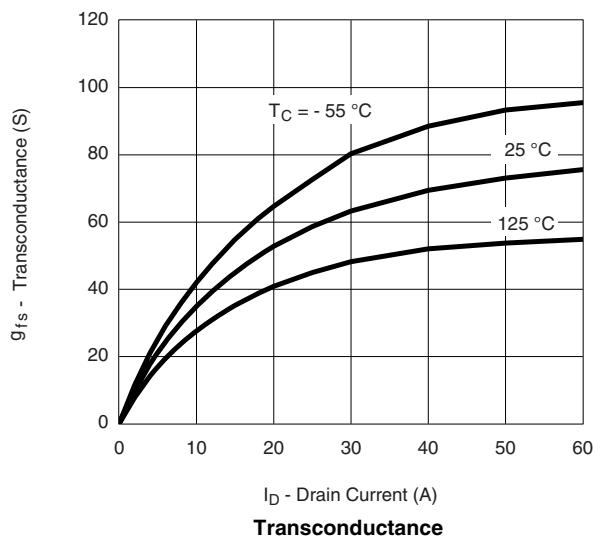
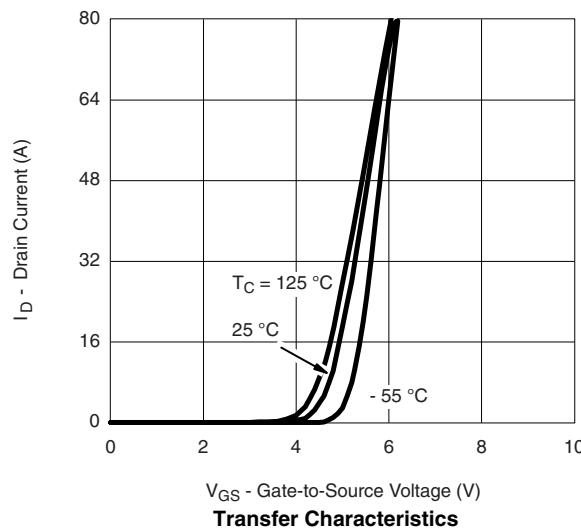
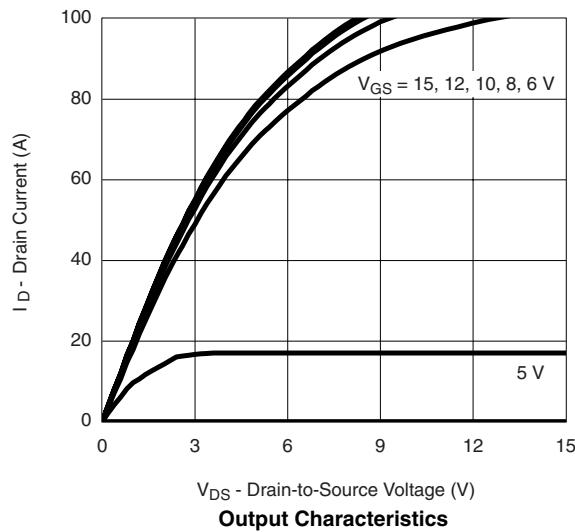
SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{DS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	2.5		4.5	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$			± 100	nA
		$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 25 \text{ V}$			± 300	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 200 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
		$V_{\text{DS}} = 200 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 100^\circ\text{C}$			25	
		$V_{\text{DS}} = 200 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 150^\circ\text{C}$			250	
On-State Drain Current ^a	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \geq 10 \text{ V}, V_{\text{GS}} = 10 \text{ V}$	40			A
Drain-Source On-State Resistance ^a	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}$		0.049	0.060	Ω
		$V_{\text{GS}} = 15 \text{ V}, I_D = 20 \text{ A}$		0.0485	0.059	
		$V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 100^\circ\text{C}$			0.110	
		$V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 150^\circ\text{C}$			0.144	
Forward Transconductance ^a	g_{fs}	$V_{\text{DS}} = 15 \text{ V}, I_D = 20 \text{ A}$	25			S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0 \text{ V}, V_{\text{DS}} = 25 \text{ V}, f = 1 \text{ MHz}$		2735		pF
Output Capacitance	C_{oss}			271		
Reverse Transfer Capacitance	C_{rss}			117		
Total Gate Charge ^c	Q_g	$V_{\text{DS}} = 100 \text{ V}, V_{\text{GS}} = 15 \text{ V}, I_D = 50 \text{ A}$		75	113	nC
Gate-Source Charge ^c	Q_{gs}			53	80	
Gate-Drain Charge ^c	Q_{gd}			14		
Gate Resistance	R_g		$f = 1 \text{ MHz}$	17.5		
Turn-On Delay Time ^c	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 100 \text{ V}, R_L = 2 \Omega$ $I_D \geq 50 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$		1.2	1.8	Ω
Rise Time ^c	t_r			16	25	ns
Turn-Off Delay Time ^c	$t_{\text{d}(\text{off})}$			170	260	
Fall Time ^c	t_f			26	40	
Source-Drain Diode Ratings and Characteristics $(T_C = 25^\circ\text{C})^b$						
Continuous Current	I_S	$I_F = 20 \text{ A}, V_{\text{GS}} = 0 \text{ V}$			33	A
Pulsed Current	I_{SM}				80	
Forward Voltage ^a	V_{SD}			0.86	1.5	V
Reverse Recovery Time	t_{rr}			114	170	ns
Peak Reverse Recovery Current	$I_{\text{RM}(\text{REC})}$			8	12	A
Reverse Recovery Charge	Q_{rr}			0.46	0.69	μC
Reverse Recovery Fall Time	t_a			82		nS
Reverse Recovery Rise Time	t_b			32		

Notes:

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

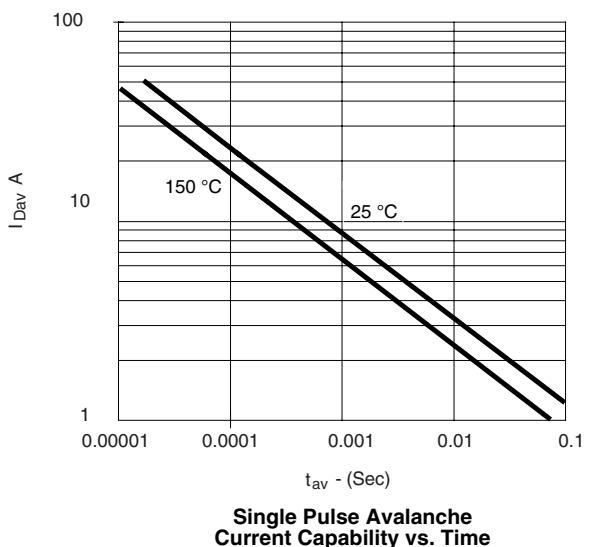
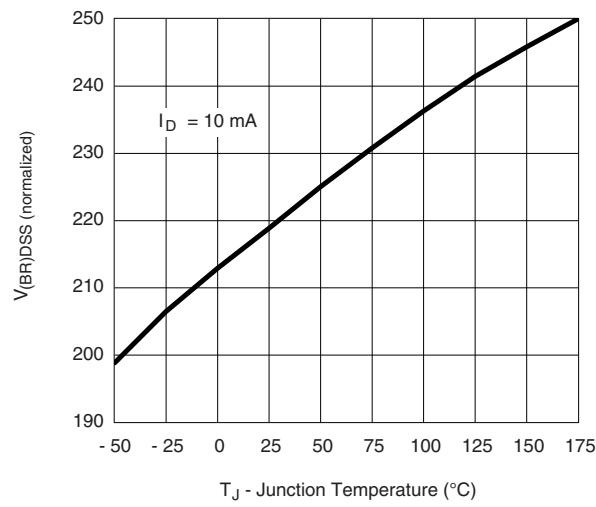
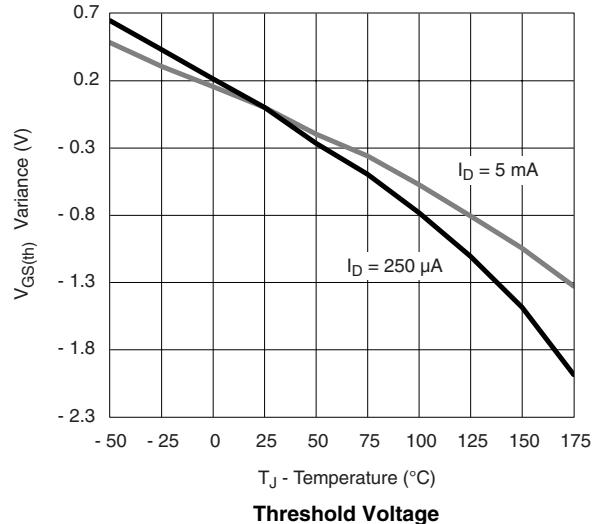
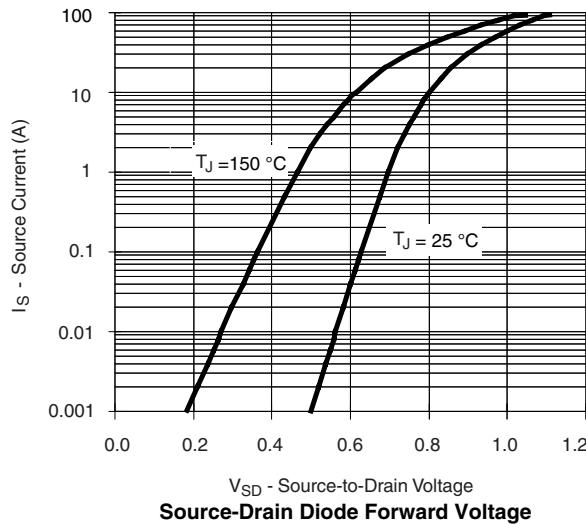
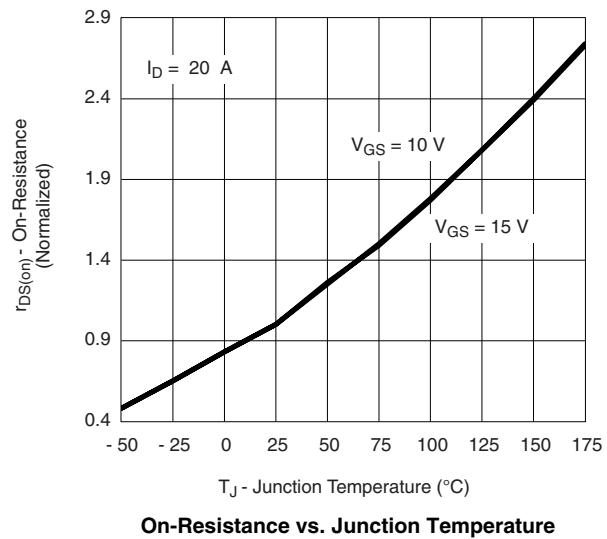
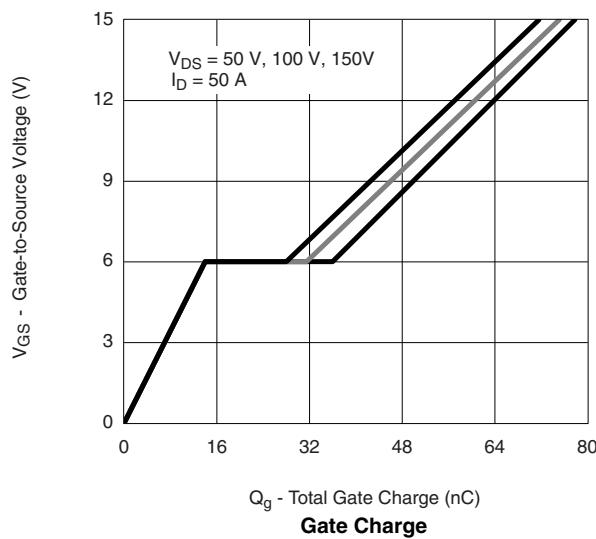
TYPICAL CHARACTERISTICS 25 °C, unless noted


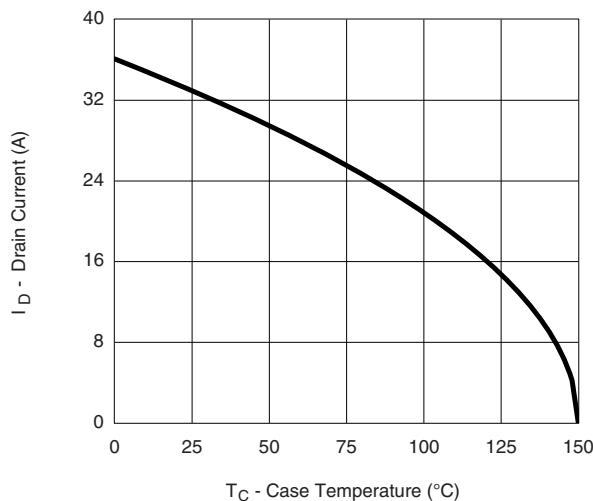
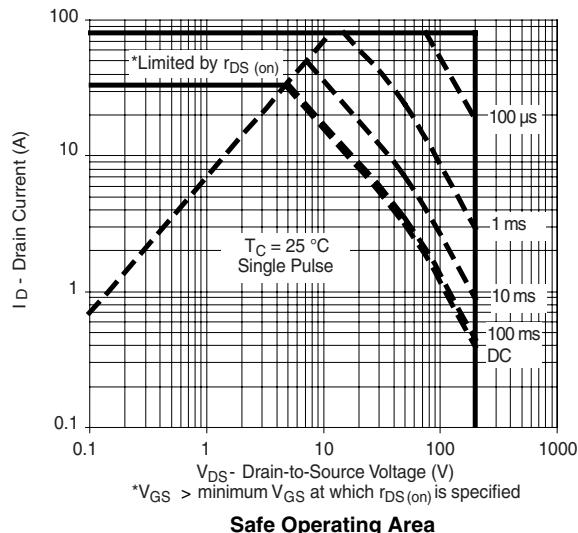
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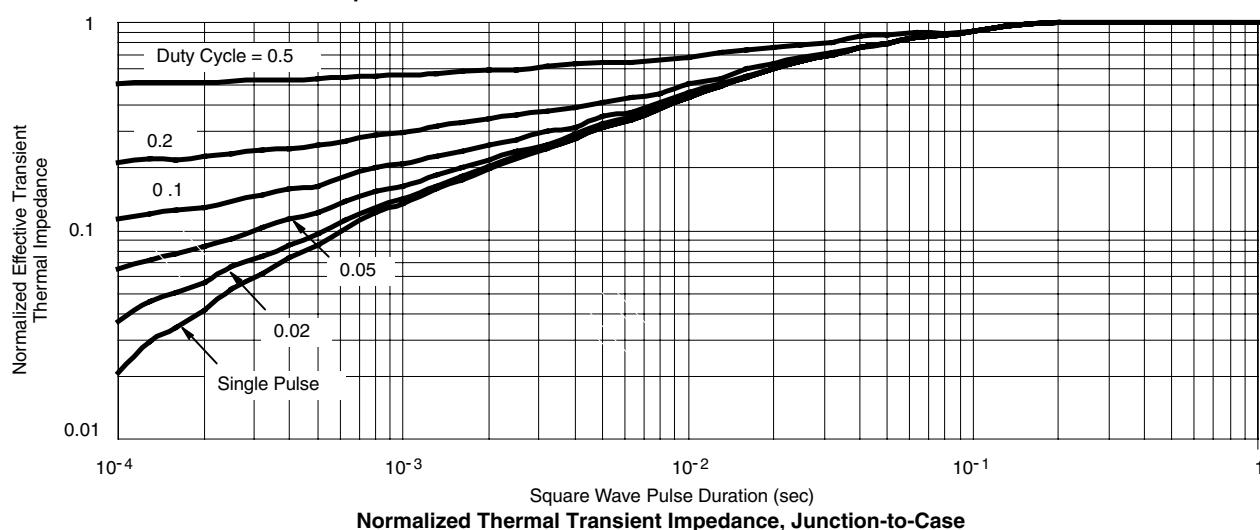
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TYPICAL CHARACTERISTICS 25 °C, unless noted



THERMAL RATINGS

**Maximum Drain Current vs.
Case Temperature**

* V_{GS} > minimum V_{GS} at which $r_{DS(on)}$ is specified

Safe Operating Area

Normalized Thermal Transient Impedance, Junction-to-Case

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